



Product Change Notification

110660 - 01

Information in this document is provided in connection with Intel® products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2011. Other names and brands may be claimed as the property of others.

BunnyPeople, Celeron, Celeron Inside, Centrino, Centrino Inside, Cilk, Core Inside, i960, Intel, the Intel logo, Intel AppUp, Intel Atom, Intel Atom Inside, Intel Core, Intel Inside, Intel Insider, the Intel Inside logo, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel Sponsors of Tomorrow, the Intel Sponsors of Tomorrow logo, Intel StrataFlash, Intel vPro, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Itanium, Itanium Inside, MCS, MMX, Moblin, Pentium, Pentium Inside, Puma, skool, the skool logo, Sound Mark, The Creators Project, The Journey Inside, Thunderbolt, vPro Inside, VTune, Xeon, and Xeon Inside are trademarks of Intel Corporation in the U.S. and/or other countries.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.



Product Change Notification

Change Notification #: 110660 - 01
Change Title: Intel(R) Server Chassis P4304XXSFCN, Single, Intel(R) Server Chassis P4304XXSHCN, Single, PCN 110660-01, Product Design, Product Design, Chassis design improvement, Reason for Revision: Updated products affected table
Date of Publication: July 20, 2011

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

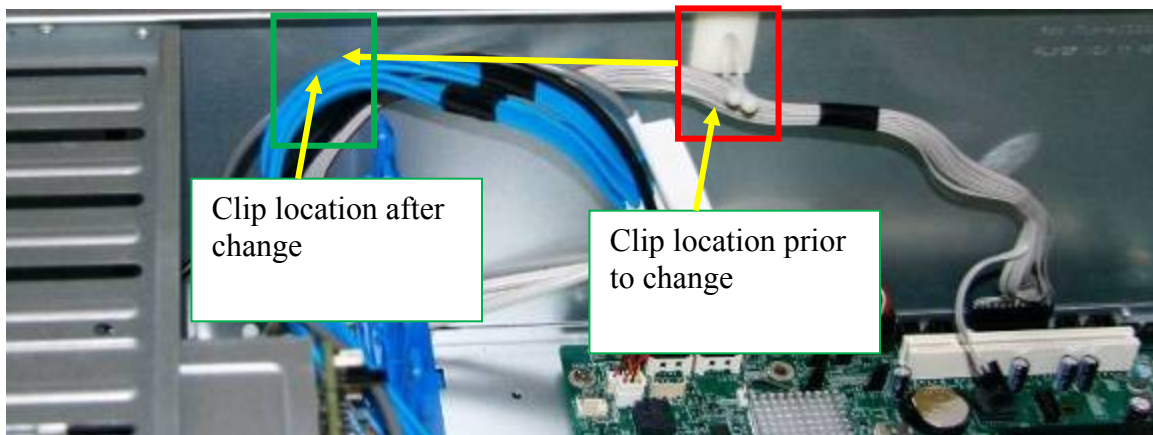
Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 5, 2011
---	-------------

Description of Change to the Customer:

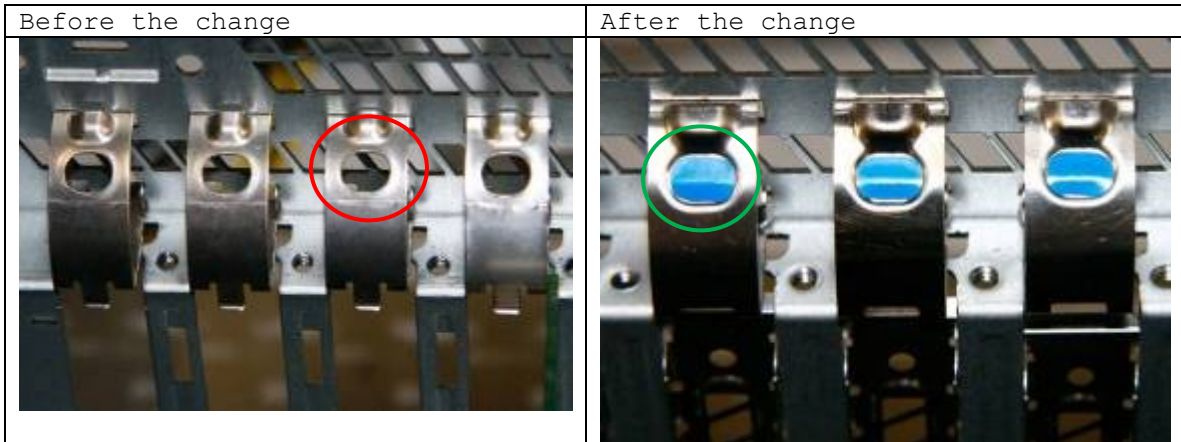
Reason for Revision: Updated products affected table

1 Intel will implement the following changes on the Intel(R) Server Chassis P4304XXSFCN and P4304XXSHCN:

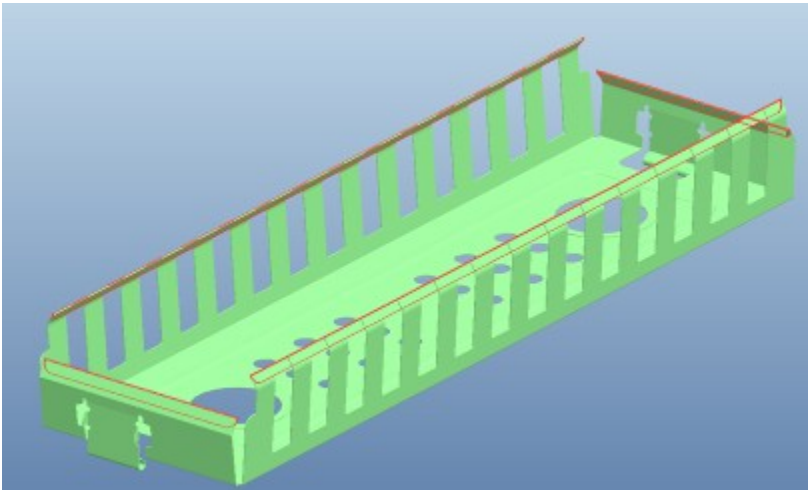
1.1 Adjust the bottom cable clip location for cables. The following is a picture of the change:



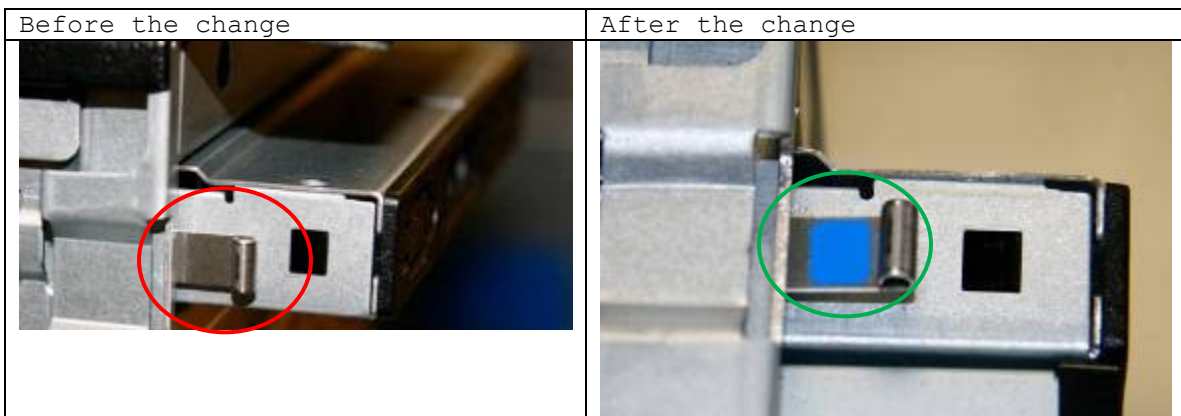
1.2 Fill the PCI retainer hole with an embossment, and add a blue Mylar on the embossment to indicate a user access point. The following are pictures of the prior and post change:



1.3 Add a hem on all edges of Optical Disk Drive (ODD) EMI cover. The following is a picture of the change:



1.4 Add blue Mylar on the front panel rail user access point, to indicate a user access point:



1.5 Updating the box labels on the outer product packaging to add the new Korea Certification (KC) mark. The following is a picture of the new KC mark:



1.6 Updating the Serial Number label on the chassis to add the manufacturing date (MMM YY). The following is a picture of the old Serial Number label:

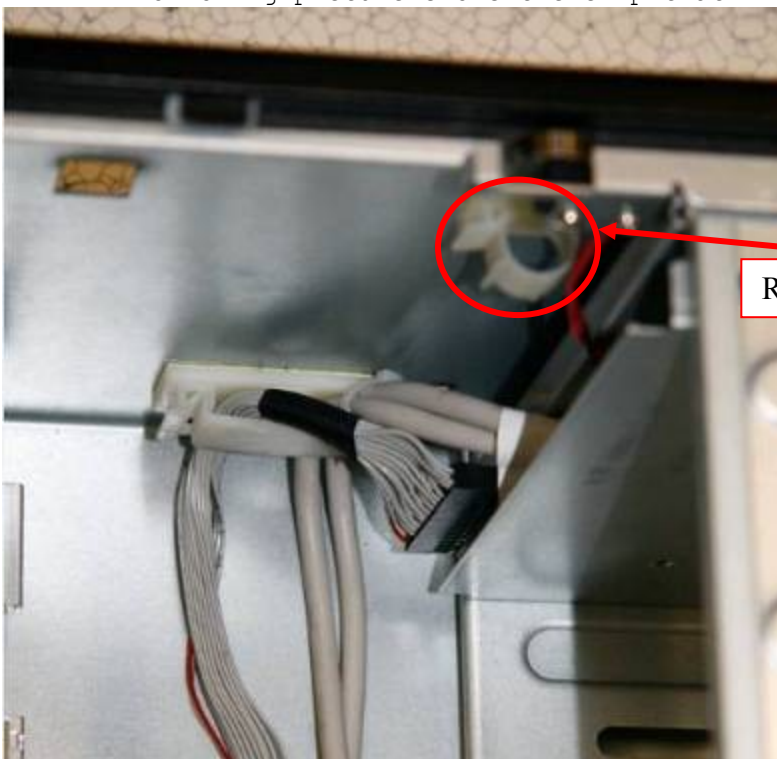


The following is a picture of the new Serial Number label:



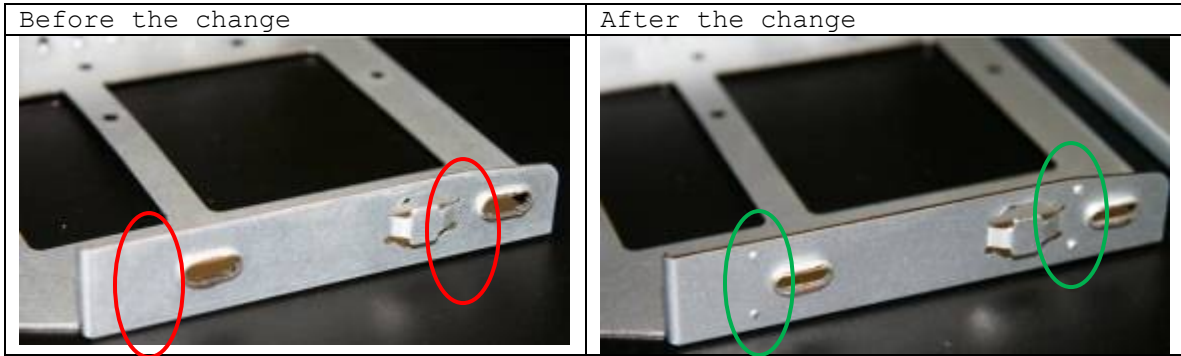
2 Intel will implement following changes on Intel(R) Server Chassis P4304XXSFCN:

2.1 Remove the redundant cable clip near the front panel. The following picture shows the clip that will be removed:

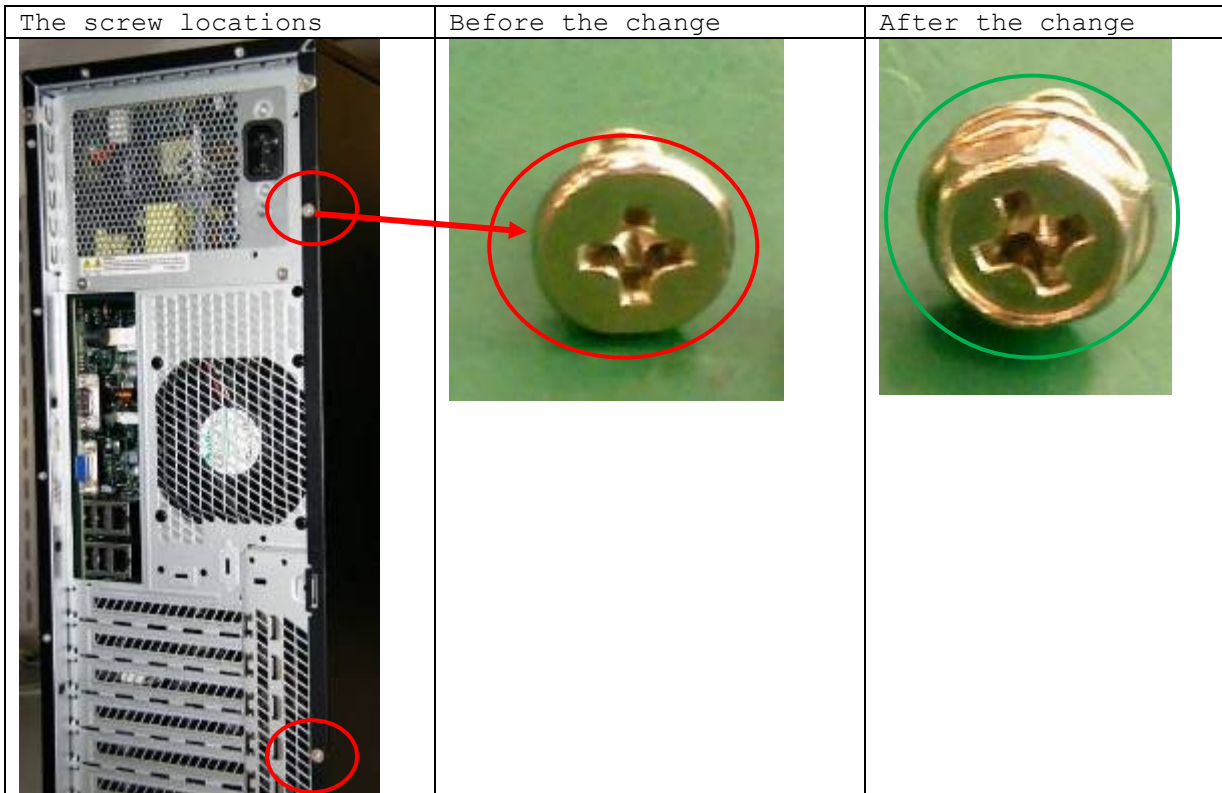


Remove the cable clip

2.2 Add dimples on the fixed hard drive tray to improve the tray lock mechanism. The following are pictures of the prior and post change:



2.3 Change the screws which are used to secure the side covers, to a different head type to differentiate them from other system screws:



Customer Impact of Change and Recommended Action:

No adverse customer impact is expected from these changes. Customers are expected to evaluate potential impact as updated product becomes available.

Customers may need to determine the need for changing of the KC marking on their products before they are exported to or sold in the Republic of Korea market.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Pre Change TA	Post Change MM#	Post Change TA
P4304XXSFCN	911754	G15844-003	911754	G15844-004
P4304XXSFCNNA	907811	G15844-003	907811	G15844-004
P4304XXSHCN	911765	G21447-002	911765	G21447-003
P4304XXSHCNNA	907812	G21447-002	907812	G21447-003

PCN Revision History:

Date of Revision:

June 15, 2011

July 20, 2011

Revision Number:

00

01

Reason:

Originally Published PCN

Updated products affected table